

Pre-Application

OMB Control Number: 0693-XXXX

Expiration Date: XX/XX/XXXX

[View Burden Statement](#)

Acknowledgement

SECTION STATUS

Not Started

Cover Page

SECTION STATUS

Not Started

Project Plan

SECTION STATUS

Not Started

Financial Information

SECTION STATUS

Not Started

CHIPS Incentive Request

SECTION STATUS

Not Started

Environmental Questionnaire

SECTION STATUS

Not Started

Workforce Development Information

SECTION STATUS

Not Started

Attestation & Submission

SECTION STATUS

Not Started

Burden Statement

A Federal agency may not conduct or sponsor, and a person is not required to respond to, nor shall a person be subject to a penalty for failure to comply with an information collection subject to the requirements of the Paperwork Reduction Act of 1995 unless the information collection has a currently valid OMB Control Number. The approved OMB Control Number for this information collection is 0693-XXXX. Without this approval, we could not conduct this information collection. Public reporting for this information collection is estimated to be approximately 60 hours per response, including the time for reviewing instructions, searching existing data sources, gathering and maintaining the data needed, and completing and reviewing the information collection. All responses to this information collection are required to obtain benefits. Send comments regarding this burden estimate or any other aspect of this information collection, including suggestions for reducing this burden to the National Institute of Standards and Technology at: askchips@chips.gov.

Acknowledgement

Any communication, data, or other information stored or transmitted on this system may be accessed and used by federal employees, consultants and contractors in accordance with Section IV.C. of the CHIPS Incentives Program – Commercial Fabrication Facilities Notice of Funding Opportunity (CHIPS-CFF NOFO). By voluntarily furnishing information through this system, the applicant consents to such access and use.

I acknowledge the above statement

Next

Cover Page

View Confidentiality Statement

Consistent with the Notice of Funding Opportunity (NOFO) for the CHIPS Incentives Program – Commercial Fabrication Facilities, NIST will treat the submitted information as confidential business information (CBI). As a result, NIST will strive to protect the submitted information by applying controls commensurate with the FIPS-199 high for confidentiality level. Information that is populated in structured questions will automatically be labeled as Controlled Unclassified Information – confidential business information (CU//PROPIN). When uploading free form documents, you are responsible for marking those documents for CBI. Please see the instructions and legend language set forth in the NOFO at section IV.C.2. Proper markings on all submitted information will assist the Department in ensuring protection from disclosure as provided by 15 U.S.C. 4652 (with certain exceptions) and Exemptions 3 and/or 4 of the Freedom of Information Act, 5 U.S.C. 552, as applicable. Please see section IV.C.1 of the NOFO for further information regarding confidentiality.

Complete the CHIPS Program Cover Page questions with the following information regarding the proposed application. The information submitted should be consistent with the information provided in the Statement of Interest. Instructions for how to complete the form are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-instructions>.

Be sure to include any statements regarding the confidentiality of information contained within the Pre-application, in accordance with Section IV.C of the NOFO.

* Name of Application

Applicant Organization Information

Provide the legal name of the entity applying for CHIPS Incentives. Note, this is not the name of the individual submitting the pre-application.

* Potential Applicant Name

Corporate Parent Name

* Street1

Street2

Steps

Cover Page

Cover Page

* Name of Application

Pre-app for Screenshots

Applicant Organization Information

Provide the legal name of the entity applying for CHIPS Incentives. Note, this is not the name of the individual submitting the pre-application.

* Potential Applicant Name

Salesforce

Corporate Parent Name

* Street1

149 Buck Run Way

Street2

* Country/Area

United States

* City

St Augustine

* State

Florida

* Postal Code

32092-0000

* Organization Website

salesforce.com

Is the applicant a consortium?

* Response

No

-- Clear --

Yes

No

An active [SAM.gov](https://sam.gov) registration is required to receive a CHIPS Incentive award; CPO recommends beginning the registration process as soon as possible.

Save and Next

* Name of Application

Pre-app for Screenshots

Applicant Organization Information

Provide the legal name of the entity applying for CHIPS Incentives. Note, this is not the name of the individual submitting the pre-application.

* Potential Applicant Name

Salesforce

Corporate Parent Name

* Street1

149 Buck Run Way

Street2

* Country/Area

United States

* City

St Augustine

* State

Florida

* Postal Code

32092-0000

* Organization Website

salesforce.com

Is the applicant a consortium?

* Response

No

Have you registered for a SAM.gov account?

* Response ⓘ

No

-- Clear --

Yes

No

Incentive award; CPO recommends beginning the registration process as soon as

Save and Next

OMB Control Number: 9999-9999
Expiration Date: 08/31/20...

Cover Page

Applicant Point of Contact

Please enter information for the applicant point of contact, who should be an individual authorized to submit an application on behalf of the entity.

* First Name	* Last Name	
<input type="text" value="Austin"/>	<input type="text" value="Fadely"/>	
* Title	* Phone Number	* Email Address
<input type="text" value="Director"/>	<input type="text" value="1234567890"/>	<input type="text" value="austinfadely@gmail.com"/>

Partnering Entities, if applicable

Are there other entities (e.g., customers, suppliers, investors, advisors) you anticipate partnering with in a meaningful way?

* Response

-- Clear --

- Yes
- No**
- Not determined at this time

- #### Steps
- ✓ Cover Page
 - Cover Page

[Previous](#) [Finish](#)

Cover Page

Applicant Point of Contact

Please enter information for the applicant point of contact, who should be an individual authorized to submit an application on behalf of the entity.

* First Name	<input type="text" value="Austin"/>	* Last Name	<input type="text" value="Fadely"/>
* Title	<input type="text" value="Director"/>	* Phone Number	<input type="text" value="1234567890"/>
		* Email Address	<input type="text" value="austinfadely@gmail.com"/>

Partnering Entities, if applicable

Are there other entities (e.g., customers, suppliers, investors, advisors) you anticipate partnering with in a meaningful way?

* Response

Attestation

Elements of this statement have been prepopulated with data submitted previously. I have reviewed the information to be submitted for accuracy and made updates where necessary.

Previous

Finish

Steps

- Cover Page
- Cover Page

Project(s) Plan Narrative

View Confidentiality Statement

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Submit a PDF attachment that provides a summary description of the project(s) that is responsive to the program description (see section I of the NOFO) and the Evaluation Criteria (see section V.A. of the NOFO). The description should contain the following categories of information:

- Description of Projects
- Consortium Description (if applicable)
- Cluster Profile
- Estimated Project Timeline
- Summary Narrative Addressing Evaluation Criteria
- CHIPS Incentives Justification
- Applicant Profile

Please refer to Section IV.H.2. of the NOFO for the specific requirements related to the Project Plan.

Required upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

FileName	Upload Date	
710631-03-10-2023 04-39-Salesforce-CHIPS-000430.webp	03/10/2023	

Optional upload – supporting project plan documents: Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Steps

- Project(s) Plan Narrative
- Project(s) Information
- Facilities Information

Project(s) Plan Narrative

> [View Confidentiality Statement](#)

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Upload

Or drop files

FileName	Upload Date	
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Steps

- Project(s) Plan Narrative
- Project(s) Information
- Facilities Information

Project(s) Information

Instructions for how to complete these questions are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-instructions>

Project(s) Description, i.e. description of the construction, expansion, or modernization activities for each proposed facility at a single location; resulting products that will be manufactured, along with information on the scale, size, and capacity of production, and any known timelines (max. 3000 characters)

* Response

Lorem

Product End Market Application, i.e., description of the types of customers and which end markets will be served by the technology being produced from each proposed facility (max. 500 characters)

* Response

Ipsum

Site Location

* City

St Augustine

* State

Florida

* ZIP Code

32092-0000

Facility Type(s) (Please select all that apply)

* Response

- Leading-Edge Facilities
- Current-Generation Facilities
- Mature Node Facilities
- Back-End Production Facilities
- Semiconductor Materials and Manufacturing Equipment Facilities
- Research and Development Facilities
- Other

Expected Total Project(s) Costs – Please provide the narrowest range possible

Steps

- Project(s) Plan Narrative
- Project(s) Information
- Facilities Information

- Mature Node Facilities
- Back-End Production Facilities
- Semiconductor Materials and Manufacturing Equipment Facilities
- Research and Development Facilities
- Other

Expected Total Project(s) Costs – Please provide the narrowest range possible

* Minimum

\$ 123

* Maximum

\$ 250

Optional commentary on range provided for Expected Total Capital Expenditures (max. 500 characters)

Response

Estimated peak monthly unit production capacity (e.g. wafers per month, components per month)

* Quantity

1

Not Applicable

Please specify unit used

* Units

widget

Attestation

Elements of this statement have been prepopulated with data submitted previously. I have reviewed the information to be submitted for accuracy and made updates where necessary.

Previous

Next

Facilities Information

Instructions for how to complete these questions are located here: <https://chips.gov/guides-and-templates-chips-incentives-program-commercial-fabrication-facilities>

According to the NOFO, an application may include one or more facilities that are / will be on the same site.

For each facility for this application, click 'Add New Facility'

Total Number of Facilities: 1

<input type="checkbox"/>	Name	Description	Technology Type	Construction Start	Production Start
1 <input type="checkbox"/>	My cool factory	Twill be epic	Question me not	08/04/2023	03/01/2025

Delete Facilities

+ Add New Facility

* Name

* Construction Start

* Production Start

* Description

Please include whether the activities at the facility will be construction, expansion, or modernization and information on the scale, size, and capacity of production, including peak

Complete this field.

* Technology Type

Describe the Technology Type and Geometry for what will be produced in this facility. If applicable. (e.g. 13nm DRAM, 40nm Logic, etc)

Complete this field.

Close

Save

Steps

- Project(s) Plan Narrative
- Project(s) Information
- Facilities Information

Instructions for how to complete these questions are located here: <https://chips.gov/guides-and-templates-chips-incentives-program-commercial-fabrication-facilities>

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1 <input type="checkbox"/>	My cool factory	Twill be epic	Question me not	08/04/2023	03/01/2025

Delete Facilities

+ Add New Facility

* Name

* Construction Start

* Description

Complete this field.

* Technology Type

Complete this field.

Close Save

A "facility" used in the context of this application refers to a leading-edge, current-generation, or mature-node facility, or a back-end production facility. Please refer to the NOFO Section I.B.1 for additional description of fabricating and packaging facilities covered by this NOFO.

- Project(s) Plan Narrative
- Project(s) Information
- Facilities Information**

Financial Information - Step 1

View Confidentiality Statement

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Primary Uploads

Submit a PDF attachment with summary narrative of financial information for the applicant and the project(s) that is responsive to the program description (see section I of the NOFO) and the Evaluation Criteria (see section V.A. of the NOFO). The financial information should include, but not be limited to, the following items:

- A. Facility Ownership Structure
- B. Sources and Uses of Funds
- C. Company Financials
- D. Summary Financials for the Project

Refer to Section IV.H.3. of the NOFO for the specific requirements related to the Financial Information section.

Required Upload - 1 pdf with narrative on the project financials with cover page indicating confidential pages

Upload

 Or drop files

FileName	Upload Date	
710631-03-10-2023 04-42-Salesforce-CHIPS-000430.webp	03/10/2023	

Optional Upload - any supporting financial information documents with cover page containing legend for confidential information in accordance with Section IV.B.2

Upload

Steps

- Financial Information - Step 1
- Financial Information - Step 2
- Financial Information - Step 3
- Financial Information - Step 4
- Financial Information - Step 5

Financial Information - Step 1

> [View Confidentiality Statement](#)

Primary Uploads

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Refer to Section IV.H.3. of the NOFO for the specific requirements related to the Financial Information section.

Required Upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

FileName	Upload Date	
710631-03-06-2023 09-59-Salesforce-CHIPS-000403.webp	03/06/2023	

Optional upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

FileName	Upload Date	
710631-03-06-2023 09-59-Salesforce-CHIPS-000403.webp	03/06/2023	

Steps

- Financial Information - Step 1
- Financial Information - Step 2
- Financial Information - Step 3
- Financial Information - Step 4
- Financial Information - Step 5

Facility Ownership Structure

Provide the formal legal entity and organizational structure for the project, showing all relevant entities, including the applicant entity, ultimate corporate parent as well as any intermediaries (if applicable).

Required Upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

FileName	Upload Date	
710631-03-06-2023 09-59-Salesforce-CHIPS-000403.webp	03/06/2023	

Project Sources & Use of Funds

Please complete the following requirements for the Sources and Uses of Funds section of the pre-application

1. Download the Sources and Uses of Funds Excel workbook (available here: <https://www.nist.gov/document/chips-nof-commercial-fabrication-facilities-pre-application-sources-and-uses-template>) and upload the completed template.
2. Complete the Uses of Funds form by entering in aggregated totals for the uses of funds for all projects within this application, provided below in the application portal. The inputs of this form should correspond with data provided in the uploaded template in the "Summation across projects" sheet of the Sources & Uses Excel workbook.
3. Upload any supporting documents related to Sources and Uses of Funds.
4. Complete the Sources of Funds questions on the subsequent pages of this web-portal by entering in aggregated totals for the uses of funds for all projects. The inputs of this form should correspond with data provided in the uploaded template in the "Summation across projects" sheet of the Sources & Uses Excel workbook.

Refer to the Sources & Uses Instruction Guide provided at <https://www.nist.gov/document/chips-nof-commercial-fabrication-facilities-pre-application-instructions> and the NOFO section IV.H.3. – "Project Sources and Uses of Funds" for the specific requirements related to sources and uses of funds.

Required upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

Project Sources & Use of Funds

Please complete the following requirements for the Sources and Uses of Funds section of the pre-application

1. Download the Sources and Uses of Funds Excel workbook (available here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-sources-and-uses-template>) and upload the completed template.
2. Complete the Uses of Funds form by entering in aggregated totals for the uses of funds for all projects within this application, provided below in the application portal. The inputs of this form should correspond with data provided in the uploaded template in the "Summation across projects" sheet of the Sources & Uses Excel workbook.
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Required upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

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Optional upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

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Or drop files

FileName	Upload Date	
710631-03-06-2023 10-00-Salesforce-CHIPS-000403.webp	03/06/2023	

Next

Financial Information SECTION STATUS [Get Started](#)

Financial Information - Step 2

Complete the summarized project sources and uses. Please ensure values for sources and uses match numbers submitted in the uploaded document in the "Summation across projects" sheet as well as the CHIPS Incentives request form.

Project - Cost Schedule

1. Capital Investment	<input type="text" value="\$ 1,200,000"/>
2. Operating losses and other cash outflows until project cash flows breakeven	<input type="text" value="\$ 500,000"/>
3. Workforce Development Costs	<input type="text" value="\$ 25,000"/>
4. Other Uses of Funds	<input type="text" value="\$ 50,000"/>
Total Project Costs	<input type="text" value="\$ 1,775,000.00"/>

[Previous](#) [Next](#)

Steps

- Financial Information - Step 1
- Financial Information - Step 2**
- Financial Information - Step 3
- Financial Information - Step 4
- Financial Information - Step 5

Financial Information - Step 3

Complete the summarized project sources and uses. Please ensure values for sources and uses match numbers submitted in the uploaded document in the "Summation across projects" sheet as well as the CHIPS Incentives request form.

Schedule B: Project - Funding Sources Schedule

1. Equity Funding

\$ 6.00

1a. Sponsor Equity (Applicant and/or Corporate Parent)

\$ 1

1b. Third-Party Equity

\$ 2

1c. Other Equity Funding

\$ 3

2. Debt Funding

\$ 22.00

2a. Sponsor Debt

\$ 4

2b. Third-Party Debt (e.g., Bonds or Loans)

\$ 5

2c. Unguaranteed portion of Third-Party Loans Guaranteed by CHIPS Program

\$ 6

2d. Other Debt Funding

\$ 7

Previous

Next

Steps

- Financial Information - Step 1
- Financial Information - Step 2
- Financial Information - Step 3**
- Financial Information - Step 4
- Financial Information - Step 5

Financial Information - Step 4

Complete the summarized project sources and uses. Please ensure values for sources and uses match numbers submitted in the uploaded document in the "Summation across projects" sheet as well as the CHIPS Incentives request form.

Schedule B: Project - Funding Sources Schedule

3. Government Support

\$ 1,002,439.00

3a. Anticipated CHIPS Direct Funding Request

\$ 1,000,000

3b. Anticipated CHIPS Loan Request

\$ 1,200

3c. Guaranteed portion of Third-Party Loans Expected to be Guaranteed by CHIPS Program

\$ 1,200

3d. Investment Tax Credit (estimated)

\$ 34

3e. State and Local Government Incentives (Grants + Loans + Tax Credits)

\$ 5

4. Other Sources of Funds

\$ 12

Total Project Funding

\$ 1,002,479.00

Previous

Next

Steps

- ✓ Financial Information - Step 1
- ✓ Financial Information - Step 2
- ✓ Financial Information - Step 3
- **Financial Information - Step 4**
- Financial Information - Step 5

Financial Information - Step 5

Company Financials

For the applicant and, as applicable, its ultimate corporate parent and any key intermediate entities, provide audited consolidated financial statements at fiscal year-end for each of the last three years, and interim financial statements for the current fiscal year. Also provide any key performance metrics (e.g., margins, return on equity), as well as details on leverage and related debt coverage metrics and ratings, as applicable, for each financial period.

Required upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

FileName	Upload Date	
710631-03-06-2023 10-02-Salesforce-CHIPS-000403.webp	03/06/2023	

Optional upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

FileName	Upload Date	
710631-03-06-2023 10-02-Salesforce-CHIPS-000403.webp	03/06/2023	

Financial Model

Provide a high-level summary of the expected revenues (broken down by number of units sold and price per unit), costs, and cash flows for each project, including key income statement, cash flow statement, and balance sheet information. Also provide a summary narrative and supporting evidence for key assumptions underlying these projections. The financial information should be in the format of a dynamic, integrated workbook in Microsoft Excel or similar program. The program should permit variable inputs to the key assumptions. The income statement, balance sheet, and statement of cash flows should be linked within the model.

Steps

- Financial Information - Step 1
- Financial Information - Step 2
- Financial Information - Step 3
- Financial Information - Step 4
- Financial Information - Step 5

Statement
Submit
Pre-App
Acknow
Cover F
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A link to an example financial model and a whitepaper describing potential core components is available here:

- Example financial model: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-example-financial-model>
- Example financial model white paper: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-example-financial-model-white>

Required upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

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CHIPS Incentives Requests

✓ View Confidentiality Statement

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Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission.

Are you requesting Direct Funding?

* Select from drop-down

Yes

Are you requesting a CHIPS Loan?

* Select from drop-down

Yes

Are you requesting for a CHIPS Loan Guarantee(s)

* Select from drop-down

Yes

Next

Steps

- CHIPS Incentives Requests
- CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- CHIPS Incentives Request Discussion

CHIPS Incentives Requests

> [View Confidentiality Statement](#)

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Are you requesting Direct Funding?

* Select from drop-down

- Yes
- No

* Select from drop-down

Next

Steps

- CHIPS Incentives Requests
- CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
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Not Started

CHIPS Incentives Requests

> [View Confidentiality Statement](#)

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Are you requesting Direct Funding?

* Select from drop-down

Are you requesting a CHIPS Loan?

* Select from drop-down

-- Clear --

Yes

No

Next

Steps

- CHIPS Incentives Requests
- CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
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CHIPS Incentives Requests

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Yes

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Yes

Are you requesting for a CHIPS Loan Guarantee(s)

* Select from drop-down

Yes

-- Clear --

Yes

No

Steps

- CHIPS Incentives Requests
- CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
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- CHIPS Incentives Request Discussion

CHIPS Direct Funding Request

Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission.

Amount requested for CHIPS Direct Funding

* In USD

Previous

Next

Steps

- ✓ CHIPS Incentives Requests
- **CHIPS Direct Funding Request**
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- CHIPS Incentives Request Discussion

CHIPS Loans Request

Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission. To the extent that requested terms differ from the baseline terms in Section I.B.8 of the NOFO, the summary should include a justification.

Amount requested for the CHIPS Loan

* In USD

Expected tenor for the CHIPS Loan

* Number of months

Financing Structure

* Select from drop-down

Error: Select from drop-down is required.

Provide any other key information for the requested CHIPS Loan (optional)

Response

Previous

Next

Steps

- ✓ CHIPS Incentives Requests
- ✓ CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- CHIPS Incentives Request Discussion

CHIPS Loans Request

Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission.
To the extent that requested terms differ from the baseline terms in Section I.B.8 of the NOFO, the summary should include a justification.

Amount requested for the CHIPS Loan

*In USD

\$ 2,000,000

Expected tenor for the CHIPS Loan

*Number of months

120

Financing Structure

*Select from drop-down

-- Clear --

- Corporate Finance
- Project Finance

Previous

Next

Steps

- ✓ CHIPS Incentives Requests
- ✓ CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- CHIPS Incentives Request Discussion

CHIPS Loan Guarantee Request

Complete the CHIPS Program Incentive Request form below in the application portal as it pertains to the projects overall. Information submitted in this form should correspond with figures uploaded in Sources & Uses template and form submission. To the extent that requested terms differ from the baseline terms in Section I.B.8 of the NOFO, the summary should include a justification.

Funding Request

Number of Loans to be Guaranteed 1

Loan Guarantee Summary (Calculated)

Third-Party Loans Guaranteed by CHIPS program \$ 400000.00
Unguaranteed portion of Third-Party Loans Guaranteed by CHIPS Program \$ 100000.00

CHIPS Loan Guarantee Request Details

	<input type="checkbox"/> Total size of th...	<input type="checkbox"/> Amount of exp...	<input type="checkbox"/> Expected Teno...	<input type="checkbox"/> Third Party Le...	<input type="checkbox"/> Additional Info...
1	<input type="checkbox"/> \$500,000.00	\$400,000.00	120	The Friggin B...	

Delete Loan Guarantee

+ Add New Loan Guarantee

* Total size of the loan

Third Party Lender, if known
(please include all if multiple)

* Amount of expected Loan request to be guaranteed through CHIPS program (up to 80%)

* Expected Tenor of the Loan

Provide any other key information for the requested CHIPS Loan Guarantee(s) (optional)

Save

Cancel

Steps

- CHIPS Incentives Requests
- CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- CHIPS Incentives Request Discussion

Credit Rating

Provide the most recent credit rating for any agency which has provided a report for the borrowing entity and / or the corporate parent or sponsoring entity to the borrowing entity (if available)

Corporate Parent Name

Wayne Enterprises

Corporate Parent Address

The Batcave

Corporate Parent UEI

123456789012

Corporate Parent Website

batman.com

<input type="checkbox"/>	Credit Rating Entity T...	Agency Providing Cre...	Corporate Credit Rating	Date of Rating
1	<input type="checkbox"/> Borrowing Entity	Lexcorp	770	03/01/2023

Delete Credit Ratings

+ Add Credit Rating

* Credit Rating Entity Type

Borrowing Entity

* Agency Providing Credit Rating

Moody's

* Corporate Credit Rating

BB+

* Date of Rating

Mar 19, 2023

Cancel

Save

Steps

- ✓ CHIPS Incentives Requests
- ✓ CHIPS Direct Funding Request
- ✓ CHIPS Loans Request
- ✓ CHIPS Loan Guarantee Request
- **Credit Rating**
- CHIPS Incentives Request Discussion

CHIPS Incentives Request Discussion

As a supplemental attachment to the answers provided in the form, please submit responses to the following:

- Provide a narrative description for how the financial information submitted for the project(s) support a conclusion that the CHIPS Incentives requested will incentivize the applicant to make investments in facilities and equipment in the United States that would not occur in the absence of the incentives.
- Provide a description of how the CHIPS Incentives requested were sized based on cash flow modeling, IRR analysis, sensitivity analysis, and other applicable analyses. Explain why the request is appropriate based on expected risks and returns of the project, historical projects of similar nature, or other relevant market benchmarks. Provide a justification for why the projected IRR in the cash flow model is appropriate for project(s) of this type, scale, and risk profile.

Refer to the CHIPS Incentives Request instruction guide located at <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-instructions> and section IV.H.3. – “CHIPS Incentive Request” of the NOFO for specific requirements regarding the CHIPS incentive request.

Required upload – Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

FileName	Upload Date	
710631-03-06-2023 10-05-Salesforce-CHIPS-000403.webp	03/06/2023	<input type="button" value="Delete"/>

Optional upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

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FileName	Upload Date	
710631-03-06-2023 10-05-Salesforce-CHIPS-000403.webp	03/06/2023	<input type="button" value="Delete"/>

Steps

- CHIPS Incentives Requests
- CHIPS Direct Funding Request
- CHIPS Loans Request
- CHIPS Loan Guarantee Request
- Credit Rating
- CHIPS Incentives Request Discussion

Environmental Questionnaire

View Burden Statement

OMB Control Number: 0693-XXXX

Expiration Date: XX/XX/XXXX

A Federal agency may not conduct or sponsor, and a person is not required to respond to, nor shall a person be subject to a penalty for failure to comply with an information collection subject to the requirements of the Paperwork Reduction Act of 1995 unless the information collection has a currently valid OMB Control Number. The approved OMB Control Number for this information collection is 0693-XXXX. Without this approval, we could not conduct this information collection. Public reporting for this information collection is estimated to be approximately 8 hours per response, including the time for reviewing instructions, searching existing data sources, gathering and maintaining the data needed, and completing and reviewing the information collection. All responses to this information collection are required to obtain benefits. Send comments regarding this burden estimate or any other aspect of this information collection, including suggestions for reducing this burden to the National Institute of Standards and Technology at: askchips@chips.gov.

View Confidentiality Statement


Submit a completed Environmental Questionnaire using the template available at this link: <https://www.nist.gov/document/chips-nof-commercial-fabrication-facilities-pre-application-environmental-questionnaire>.

Refer to Section VI.C.2 of the NOFO for more information.

Required upload â€” Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Or drop files

FileName	Upload Date	
CD511-V1.1	03/20/2023	

Steps

- Environmental Questionnaire

Environmental Questionnaire

> View Burden Statement

∨ View Confidentiality Statement

Consistent with the Notice of Funding Opportunity (NOFO) for the CHIPS Incentives Program – Commercial Fabrication Facilities, NIST will treat the submitted information as confidential business information (CBI). As a result, NIST will strive to protect the submitted information by applying controls commensurate with the FIPS-199 high for confidentiality level. Information that is populated in structured questions will automatically be labeled as Controlled Unclassified Information – confidential business information (CU//PROPIN). When uploading free form documents, you are responsible for marking those documents for CBI. Please see the instructions and legend language set forth in the NOFO at section IV.C.2. Proper markings on all submitted information will assist the Department in ensuring protection from disclosure as provided by 15 U.S.C. 4652 (with certain exceptions) and Exemptions 3 and/or 4 of the Freedom of Information Act, 5 U.S.C. 552, as applicable. Please see section IV.C.1 of the NOFO for further information regarding confidentiality.

Submit a completed Environmental Questionnaire using the template available at this link: <https://www.nist.gov/document/chips-nof-commercial-fabrication-facilities-pre-application-environmental-questionnaire>.

Refer to Section VI.C.2 of the NOFO for more information.

Required upload – Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

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710631-03-10-2023 08-57-Salesforce-CHIPS-000430.webp	03/10/2023	

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Upload

Steps

Environmental Questionnaire

Environmental Questionnaire

> View Burden Statement

> View Confidentiality Statement

Submit a completed Environmental Questionnaire using the template available at this link: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-environmental-questionnaire>.

Refer to Section VI.C.2 of the NOFO for more information.

Required upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

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FileName	Upload Date	
710631-03-06-2023 10-06-Salesforce-CHIPS-000403.webp	03/06/2023	

Optional upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

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FileName	Upload Date	
710631-03-06-2023 10-06-Salesforce-CHIPS-000403.webp	03/06/2023	

Save

Steps

Environmental Questionnaire

Workforce Development Information

View Confidentiality Statement

Consistent with the Notice of Funding Opportunity (NOFO) for the CHIPS Incentives Program – Commercial Fabrication Facilities, NIST will treat the submitted information as confidential business information (CBI). As a result, NIST will strive to protect the submitted information by applying controls commensurate with the FIPS-199 high for confidentiality level. Information that is populated in structured questions will automatically be labeled as Controlled Unclassified Information – confidential business information (CUI//PROPIN). When uploading free form documents, you are responsible for marking those documents for CBI. Please see the instructions and legend language set forth in the NOFO at section IV.C.2. Proper markings on all submitted information will assist the Department in ensuring protection from disclosure as provided by 15 U.S.C. 4652 (with certain exceptions) and Exemptions 3 and/or 4 of the Freedom of Information Act, 5 U.S.C. 552, as applicable. Please see section IV.C.1 of the NOFO for further information regarding confidentiality.

Submit a PDF attachment with information on the three topics below regarding workforce development that is responsive to the Workforce Development Evaluation Criteria (see section V.A.5. in the NOFO).

1. Approach to recruit, train, and retain a diverse and skilled set of workers to fill the good jobs that will be created to construct, expand, and operate its semiconductor facilities. Provide a description of:
 - Anticipated facility workforce needs
 - Proposed strategy to meet facility workforce needs including policies to promote the hiring and retention of economically disadvantaged individuals
 - Approach to meeting the Good Jobs Principles
 - Proposed high-quality education and training programs or strategies, such as Registered Apprenticeships, pre-apprentice programs, career and college pathways
 - Proposed wraparound support services
 - Actions the applicant has taken to engage with potential strategic partners
 - Actions the applicant has taken with respect to creating or participating in a sectoral partnership, such as convening or conducting outreach to potential partner organizations, defining respective roles and responsibilities, or identifying a backbone organization to lead the sectoral partnership
2. The status and goals of discussions with workforce, educational, community-based, public-sector, local housing, or other organizations on proposed collaborations, to the extent they have not yet been finalized.
3. Details on any conversations or planning done, in concert with partners, for meeting construction workforce needs (a construction workforce plan is not required in the Pre-Application stage)

Please refer to Section IV.H.5. of the NOFO for more details on expectations for workforce development information.

Required upload - Please include supporting documents including a cover page containing a legend for confidential information in accordance with Section IV.C.2 of the NOFO

Upload

Steps

- Workforce Development Information

Workforce Development Information

> [View Confidentiality Statement](#)

Submit a PDF attachment with information on the three topics below regarding workforce development that is responsive to the Workforce Development Evaluation Criteria (see section V.A.5. in the NOFO).

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Workforce Development Information

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Upload


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FileName	Upload Date	
710631-03-06-2023 10-06-Salesforce-CHIPS-000403.webp	03/06/2023	


Instructions for completing this form are located here: <https://www.nist.gov/document/chips-nofo-commercial-fabrication-facilities-pre-application-instructions>.

Provide an estimate of the number of jobs that will be created during the construction phase of the project(s). Do not include any jobs that will be performed outside of the United States.

Direct jobs on the construction site(s): Enter an estimate for the number of jobs that will be directly involved in the construction activities for the construction, expansion, or modernization of a facility. Examples include laborers and foremen for construction activities.

* Number of jobs 

Indirect jobs: Enter an estimate for the number of jobs that will be indirectly involved in the construction activities for the construction, expansion, or modernization of a facility. Examples include contracted equipment suppliers and technicians, architects and engineers consulted.

* Number of jobs 

Provide an explanation of your job creation estimates above. Provide any assumptions, sources, or other explanations for the estimates included for direct or indirect jobs created.

* Response

Provide an estimate of the number of jobs that will be created during the production phase of the project(s). Do not include any jobs that will be performed outside of the United States.

Direct jobs in production: Enter an estimate for the number of jobs that will be directly involved in the operation of the facility or facilities. This includes all employees of the entity that will be onsite for activities relating to manufacturing, overhead, research & development, and administration.

* Number of jobs ⓘ

Indirect jobs: Enter an estimate for the number of jobs that will be indirectly involved in the construction activities for the construction, expansion, or modernization of a facility. Examples include contracted equipment suppliers and technicians, architects and engineers consulted.

* Number of jobs ⓘ

Provide an explanation of your job creation estimates above. Provide any assumptions, sources, or other explanations for the estimates included for direct or indirect jobs created.

* Response

Provide an estimate of the number of jobs that will be created during the production phase of the project(s). Do not include any jobs that will be performed outside of the United States.

Direct jobs in production: Enter an estimate for the number of jobs that will be directly involved in the operation of the facility or facilities. This includes all employees of the entity that will be onsite for activities relating to manufacturing, overhead, research & development, and administration.

* Number of jobs ⓘ


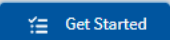
Indirect jobs: Enter an estimate for the number of jobs that will be created in the broader ecosystem as a result of operating the facility or facilities. Examples include incremental needs for materials suppliers (e.g., silicon, chemicals, consumables), utilities suppliers, contractors for equipment needs (e.g., cleaning and repair), product transport, etc.

* Number of jobs ⓘ

Provide an explanation of your job creation estimates above. Provide any assumptions, sources, or other explanations for the estimates included for direct or indirect jobs created.

* Response

Save

Project Plan	SECTION STATUS Completed	
Financial Information	SECTION STATUS Completed	
CHIPS Incentive Request	SECTION STATUS Completed	
Environmental Questionnaire	SECTION STATUS Completed	
Workforce Development Information	SECTION STATUS Completed	
Attestation & Submission <small>You must be on one of these supported browsers to submit: Chrome, Firefox, Edge</small>	SECTION STATUS Not Started	



The SOI, Pre Application, and Full Application must be submitted using one of the following supported browsers: Chrome, Edge, Firefox

Application Workspace

[Application Team](#)[Submissions](#)[Withdraw Submission](#)

Statement of Interest

OMB Control Number: 0693-0091

Expiration Date: 08/31/2023

[View Burden Statement](#)**Acknowledgement****SECTION STATUS**

Submitted

[Submitted](#)**Statement of Interest****SECTION STATUS**

Submitted

[Submitted](#)**Submit Statement of Interest****SECTION STATUS**

Submitted

[Submitted](#)

Pre-Application

OMB Control Number: 9999-9999

Expiration Date: 08/31/2023

[View Burden Statement](#)

Attest and Submit

YOU MUST BE ON ONE OF THESE SUPPORTED BROWSERS TO SUBMIT: CHROME, FIREFOX, EDGE

The CHIPS Program Office (CPO) recognizes the importance of protecting confidential business information and will follow all applicable laws to protect such information, including, for example, the CHIPS Act, the Trade Secrets Act, and the Freedom of Information Act. Please refer to Section IV.C. of the CHIPS Incentives Program – Commercial Fabrication Facilities Notice of Funding Opportunity (CHIPS-CFF NOFO) for a further discussion of these laws.

Submission Certifications

Attestation

The individual submitting the Pre-Application certifies on behalf of the applicant entity that the applicant information and data submitted and the representations made in the Pre-Application are true, complete and accurate, to the best of the applicant's knowledge and belief after due inquiry.

Attestation

The individual submitting the Pre-Application certifies on behalf of the applicant that the applicant understands that CPO and the Department of Commerce will rely on the accuracy and completeness of the applicant information and data submitted and the representations made in the Pre-Application and that any false, fictitious or fraudulent statement or representation made in the Pre-Application may be the basis for rejection of the Pre-Application or subject the applicant to criminal, civil, or administrative penalties. (18 U.S. Code, Section 1001.)

Attestation

The individual submitting the Pre-Application certifies on behalf of the applicant that the applicant understands that any applicant information and data contained in the Pre-Application may be accessed and used by federal employees, consultants and contractors in

Steps

- Attest and Submit
- View PDF
- Confirmation

The individual submitting the Pre-Application certifies on behalf of the applicant that the applicant understands that any applicant information and data contained in the Pre-Application may be accessed and used by federal employees, consultants and contractors in accordance with CHIPS-CFF NOFO, Section IV.C. (Confidential Information).

*

Attestation

The individual submitting the Pre-Application certifies that they possess the full legal power and authority to submit the Pre-Application and make the preceding certifications on behalf of the applicant.

*

Public Communications

Attestation

The individual submitting the Pre-Application agrees that neither the applicant entity nor any of its affiliates may issue any press release or otherwise publicly disclose the status of the Pre-Application or the contents of any communications with CPO or the Department of Commerce without CPO's prior written consent.

*

Attestation

The individual submitting the Pre-Application certifies that they possess the full legal power and authority to bind the applicant.

*

Salesforce
Director
Austin Fadely

Next

Environmental Questionnaire

SECTION STATUS

Confirmation

You may download a PDF of your Statement of Interest using the link below.

[Download Link](#)

[Finish](#)

Steps

- Attest and Submit
- View PDF
- Confirmation

Full Application

CUI//PROPIN

CHIPS Pre-Application

Cover Page

Application Information	
Title of Application	Pre-app for Screenshots
Potential Applicant's Legal Name	Salesforce
Applicant Corporate Parent	Wayne Enterprises
Mailing Address - Street	149 Buck Run Way
Mailing Address - City, State, Postal Code, Country/Area	St Augustine, FL, 32092-0000, US
Website	salesforce.com
Is the applicant a consortium?	No
Have you registered for a SAM.gov account?	No
UEI #	
Applicant Point of Contact	
Title	Director
Name	Austin Fadely
Email	austinfadely@gmail.com
Phone	1234567890
Project Cluster Information, If Applicable	
Are there other entities (e.g., customers, suppliers, investors, advisors) you anticipate partnering with in a meaningful way?	No
Please describe any potential partners referred to above. (max. 1500 characters)	

CUI//PROPIN

CUI//PROPIN